PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chin-I Liao	10/27/2011
Teng-Chun Hsuan	10/27/2011
Chin-Cheng Chien	10/27/2011

RECEIVING PARTY DATA

Name:	UNITED MICROELECTRONICS CORP.	
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park	
City:	Hsin-Chu City	
State/Country:	e/Country: TAIWAN	

PROPERTY NUMBERS Total: 1

	Property Type	Number
Aţ	oplication Number:	13286222

CORRESPONDENCE DATA

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via US Mail.

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ATTORNEY DOCKET NUMBER: NAUP1388USA

NAME OF SUBMITTER: JANINE CHANG

Total Attachments: 2 source=1234113#page1.tif source=1234113#page2.tif

PATENT

REEL: 027151 FRAME: 0456

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

	R(S) (Inventors):	
Name:	Chin-I Liao	Nationality: TW
Name:	Teng-Chun Hsuan	Nationality: TW
Name:	Chin-Cheng Chien	Nationality: TW
ereby sells,	, assigns and transfers to	
Name:		CORR
Namei	: UNITED MICROELECTRONICS CORP. ess: No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwar R.O.C.	
	ss: No.3, Li-Hsin Road 2, Science-Bas	
Addres	No.3, Li-Hsin Road 2, Science-Bas R.O.C.	sed Industrial Park, Hsin-Chu City 300, Taiwan, EE the entire right, title, and interest in and to
Addres	No.3, Li-Hsin Road 2, Science-Bas R.O.C.	sed Industrial Park, Hsin-Chu City 300, Taiwan, EE the entire right, title, and interest in and to ne invention entitled:
Addrese and the successive and all is: "SEM	cessors and assignees of the ASSIGNI mprovements which are disclosed in the ICONDUCTOR DEVICE AND METHOD (sed Industrial Park, Hsin-Chu City 300, Taiwan, EE the entire right, title, and interest in and to ne invention entitled:
Addrese and the successive and all in "SEM	ess: No.3, Li-Hsin Road 2, Science-Bas R.O.C. cessors and assignees of the ASSIGNI improvements which are disclosed in the ICONDUCTOR DEVICE AND METHOD (cound in :	sed Industrial Park, Hsin-Chu City 300, Taiwan, EE the entire right, title, and interest in and to ne invention entitled: OF FORMING EPITAXIAL LAYER"
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Assignment, Page 1 of 2

NPO#NAU-P1388-USA:0 CUST#UMCD-2011-0188 F#NPO-P0002E-US1 DSC0-100U010498 and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this OCT 2 7 2011 (Date of signing). (纳翰明人杨必接着上列目期 •)

(Type name of inventor)	Signature of INVENTOR
Chin-I Liao	<u> </u>
Teng-Chun Hsuan	Teng-Chun Hsuan.
Chin-Cheng Chien	chim chang shren
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RECORDED: 11/01/2011

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